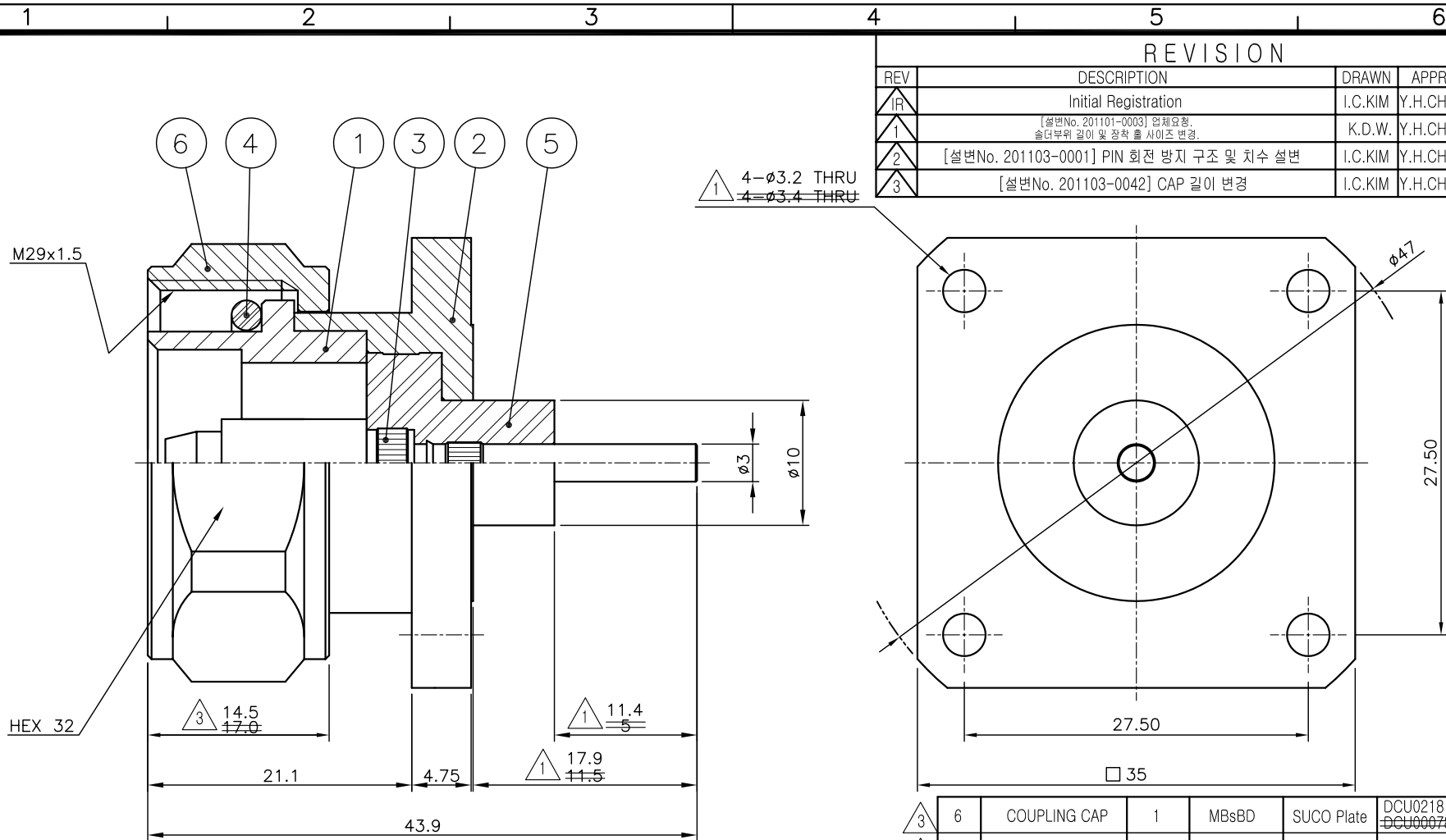




REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	Y.H.CHO	2010.07.13.
1	[설변No. 201101-0003] 설계요청, 솔더부위 길이 및 장착 홀 사이즈 변경.	K.D.W.	Y.H.CHO	2011.01.25.
2	[설변No. 201103-0001] PIN 회전 방지 구조 및 치수 설변	I.C.KIM	Y.H.CHO	2011.03.02.
3	[설변No. 201103-0042] CAP 길이 변경	I.C.KIM	Y.H.CHO	2011.03.28.

3	6	COUPLING CAP	1	MBsBD	SUCO Plate	DCU02181-5/1 DCU00078-5/1 (K5015)
2	5	INSULATOR	1	TEFLON		DIN01818-N/1
	4	GASKET	1	SILICONE RUB		DGK00054-N/1
2	3	CONTACT	1	MBsBD	Silver Plate 7μm	DCT02408-5/1 DCT02390-5/1
2	2	사각 BODY	1	MBsBD	SUCO Plate 3μm	DBD02884-5/1 DBD02800-5/1
	1	원형 BODY	1	MBsBD	SUCO Plate 3μm	DBD02285-5/2
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2011. 03. 28.	
	Angle	APPROVED BY Y.H.CHOI	
MATERIAL	-	CHECKED BY	
		DRAWN BY I.C.KIM	
FINISH	-	SCALE	UNIT
		2/1	mm

RF & MICROWAVE TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE
7/16 DIN50 SOLDER END PS-4H
DWG NO. CN02589-7/3
REVISION 3
SHEET 1 of 1

주 기

1. □ 35 4면 엔드밀 작업시 적용 치수 (□35~□34.6)